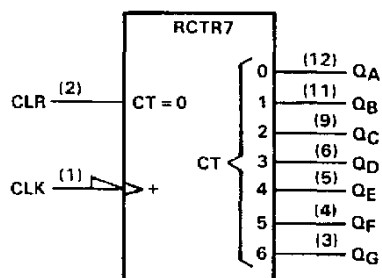


The 'HC4024 is an asynchronous 7-stage binary counter designed with an input pulse-shaping circuit. The outputs of all stages are available externally. A high clear signal asynchronously clears the counter and resets all outputs low. The count is advanced on the high-to-low transition of the clock pulse. Applications include time-delay circuits, counter controls, and frequency-dividing circuits.

logic symbol[†]



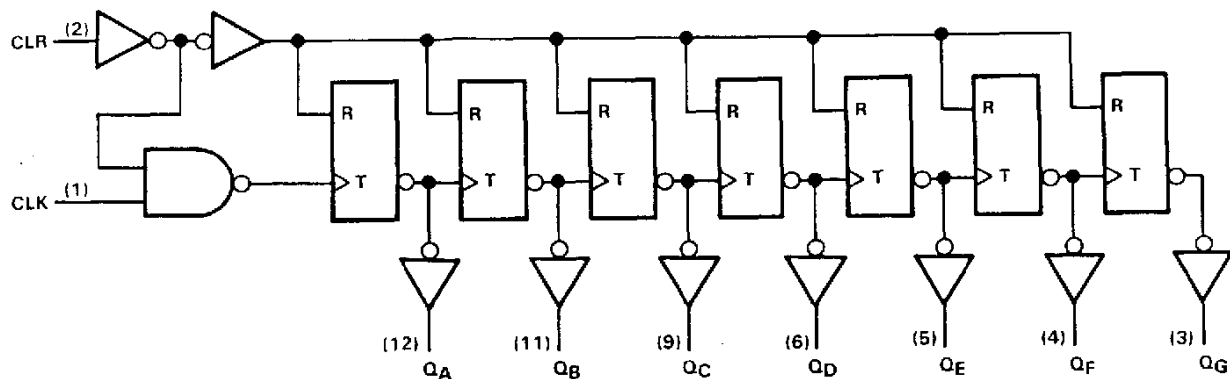
Pin numbers shown are for D, J, and N packages.

CLK	1	14	VCC
CLR	2	13	NC
Q _G	3	12	Q _A
Q _F	4	11	Q _B
Q _E	5	10	NC
Q _D	6	9	Q _C
GND	7	8	NC

NC—No internal connection

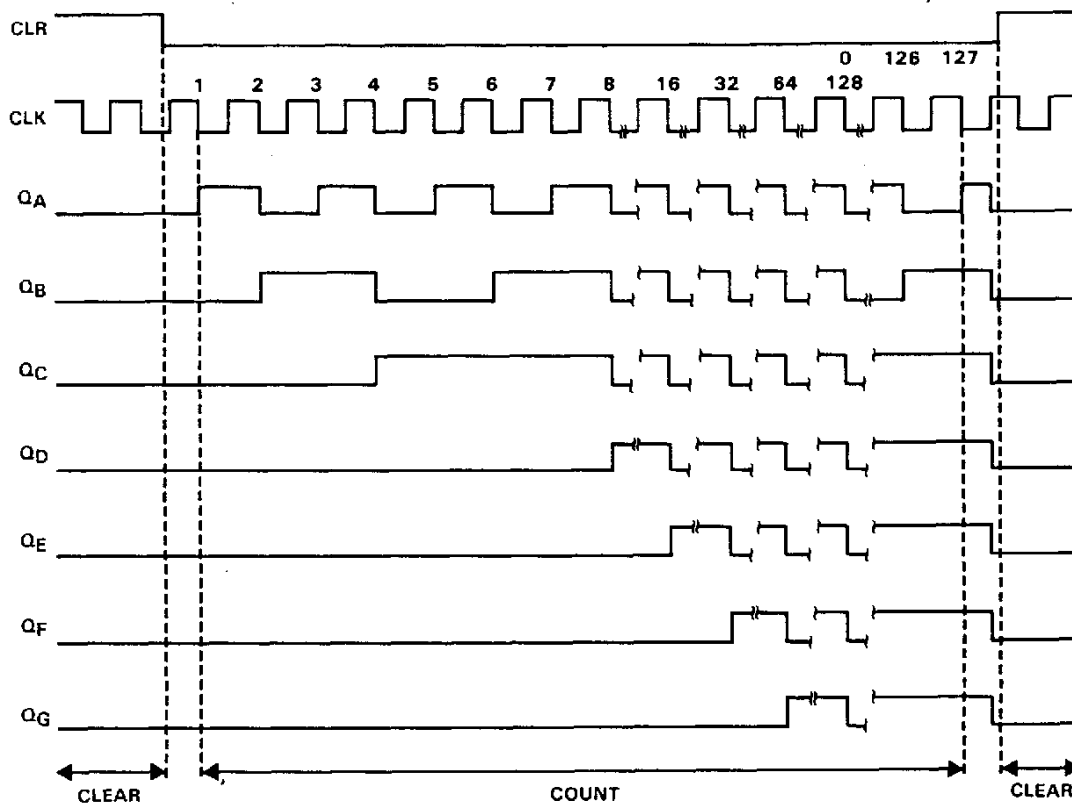
SN54HC4024, SN74HC4024 **ASYNCHRONOUS 7-BIT BINARY COUNTERS**

logic diagram (positive logic)



Pin numbers shown are for D, J, and N packages.

typical clear and count sequence



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SN54HC4024, SN74HC4024

ASYNCHRONOUS 7-BIT BINARY COUNTERS

absolute maximum ratings over operating free-air temperature range†

Supply voltage, V_{CC}	-0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 25 mA
Continuous current through V_{CC} or GND pins	± 50 mA
Lead temperature 1,6 mm (1/16 in) from case for 60 s: FK or J package	300°C
Lead temperature 1,6 mm (1/16 in) from case for 10 s: D or N package	260°C
Storage temperature range	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54HC4024			SN74HC4024			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	2	5	6	2	5	6	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			V
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			V
V_I	Input voltage	0		V_{CC}	0		V_{CC}	V
V_O	Output voltage	0		V_{CC}	0		V_{CC}	V
t_t	Input transition (rise and fall) times	$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			$V_{CC} = 2$ V $V_{CC} = 4.5$ V $V_{CC} = 6$ V			ns
T_A	Operating free-air temperature	-55		125	-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25^\circ\text{C}$			SN54HC4024		SN74HC4024		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	$V_I = V_{IH}$ or V_{IL} , $I_{OH} = -20 \mu\text{A}$	2 V	1.9	1.998		1.9		1.9		V
		4.5 V	4.4	4.499		4.4		4.4		
		6 V	5.9	5.999		5.9		5.9		
	$V_I = V_{IH}$ or V_{IL} , $I_{OH} = -4$ mA	4.5 V	3.98	4.30		3.7		3.84		
V_{OL}	$V_I = V_{IH}$ or V_{IL} , $I_{OL} = 20 \mu\text{A}$	2 V		0.002	0.1		0.1		0.1	V
		4.5 V		0.001	0.1		0.1		0.1	
		6 V		0.001	0.1		0.1		0.1	
	$V_I = V_{IH}$ or V_{IL} , $I_{OL} = 4$ mA	4.5 V		0.17	0.26		0.4		0.33	
	$V_I = V_{IH}$ or V_{IL} , $I_{OL} = 5.2$ mA	6 V		0.15	0.26		0.4		0.33	
I_I	$V_I = V_{CC}$ or 0	6 V	± 0.1 ± 100			± 1000		± 1000		nA
I_{CC}	$V_I = V_{CC}$ or 0, $I_O = 0$	6 V	8			160		80		μA
C_i		2 to 6 V	3 10			10		10		pF

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SN54HC4024, SN74HC4024
ASYNCHRONOUS 7-BIT BINARY COUNTERS

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V _{CC}	T _A = 25 °C		SN54HC4024		SN74HC4024		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	2 V	0	5.5	0	3.7	0	4.3	MHz
		4.5 V	0	28	0	19	0	22	
		6 V	0	33	0	22	0	25	
t _w	Pulse duration	CLK high or low	2 V	90	135		115		ns
			4.5 V	18	27		23		
			6 V	15	23		20		
	CLR high		2 V	80	120		100		ns
			4.5 V	16	24		20		
			6 V	14	20		17		
t _{su}	Setup time, CLR low before CLK↓	2 V	80		120		100		ns
		4.5 V	16		24		20		
		6 V	14		20		17		

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), C_L = 50 pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25 °C			SN54HC4024		SN74HC4024		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}		Q _A	2 V	5.5	10		3.7		4.3		MHz
			4.5 V	28	50		19		22		
			6 V	33	60		22		26		
t _{pd}	CLK	Q _A	2 V		56	120		180		150	ns
			4.5 V		16	24		36		30	
			6 V		12	20		31		26	
t _{PHL}	CLR	Any	2 V		61	130		195		165	ns
			4.5 V		17	26		39		32	
			6 V		13	22		33		28	
t _t		Q _A	2 V		28	75		110		95	ns
			4.5 V		8	15		22		19	
			6 V		6	13		19		16	

C _{pd}	Power dissipation capacitance	No load, T _A = 25 °C	40 pF typ
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Note 1: Load circuits and voltage waveforms are shown in Section 1.



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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
86012012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Call TI	
8601201CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Call TI	
SN54HC4024J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
SN74HC4024N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SNJ54HC4024FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
SNJ54HC4024J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN54HC4024, SN74HC4024 :

- Catalog: [SN74HC4024](#)
- Military: [SN54HC4024](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



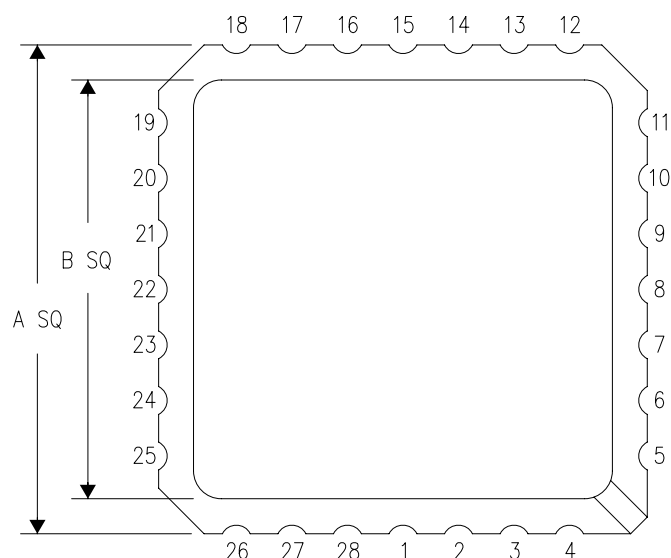
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

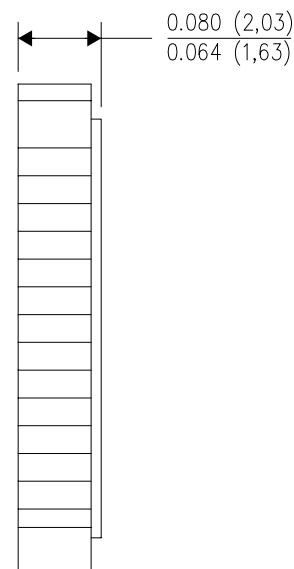
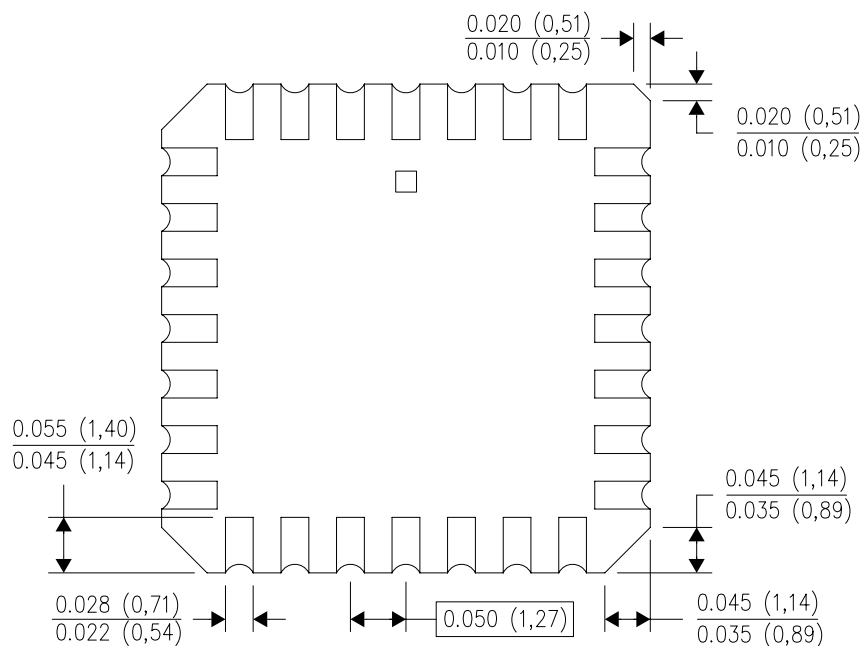
FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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